

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	64	(first upper) adj2 lead adj frame and (second lower) adj2 lead adj frame and MOSFET and (encapsulat\$4 mold\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/31 15:08
L3	46	(first upper) adj2 lead adj frame and (second lower) adj2 lead adj frame and diode adj2 (chip die ic) and (encapsulat\$4 mold\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/31 15:17
L4	167	lead adj frame and diode adj2 (chip die ic) and (encapsulat\$4 mold\$) and cathode and anode	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/31 15:20